



SURFACE MOUNT

Bandpass Filter

EBPF-545-1+

50Ω 340 to 750 MHz

FEATURES

- Miniature shielded package
- Low insertion loss
- High rejection

APPLICATIONS

- Defense / Military
- Military Radio Communications

CASE STYLE: HE1354

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

ELECTRICAL SPECIFICATIONS AT -40°C TO 85°C

Parameter	F#	Frequency (MHz)	Min.	Typ.	Max.	Units
Passband	F1-F2	340 - 750	—	1	1.7	dB
Stop Band, Lower	DC-F3	DC - 135	35	—	—	dB
Stop Band, Upper	F5	900	10	17	—	dB
	F6-F7	1000 - 2000	35	—	—	dB

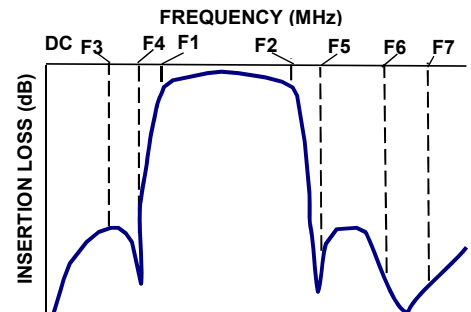
MAXIMUM RATINGS

Parameter	Ratings
Operating temperature	-40°C to +85°C
Storage temperature	-55°C to +100°C
RF Power Input *	27 dBm (CW)

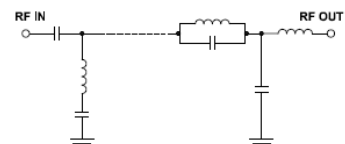
Permanent damage may occur if any of these limits are exceeded.

*Passband rating

TYPICAL FREQUENCY RESPONSE



FUNCTIONAL SCHEMATIC



REV. X0
ECO-014662
EBPF-545-1+
EDUXXXX
URJ
220822



Mini-Circuits®

SURFACE MOUNT

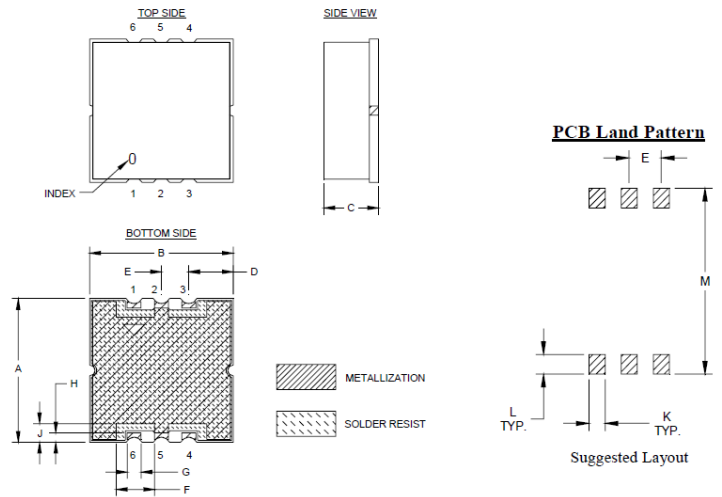
Bandpass Filter

EBPF-545-1+

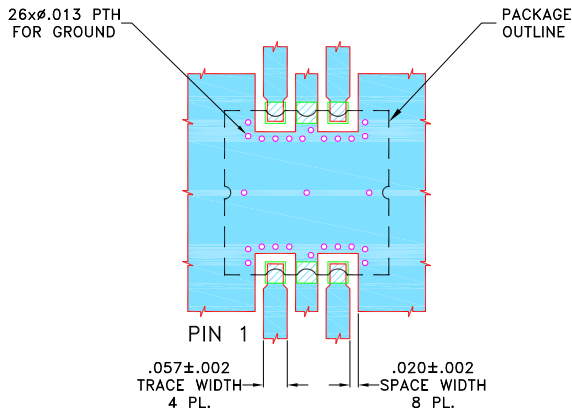
PAD CONNECTIONS

RF IN	1
RF OUT	6
GROUND	2,5
NOT USED	3,4

OUTLINE DRAWING



DEMO BOARD MCL P/N: TB-XXXX+
SUGGESTED PCB LAYOUT (PL-680)



NOTES:

1. TRACE WIDTH IS SHOWN FOR ROGERS (R04350B) WITH DIELECTRIC THICKNESS $.030\pm.002$ ". COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

 DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

 DENOTES COPPER LAND PATTERN FREE OF SOLDERMASK

OUTLINE DIMENSIONS (Inches)

A	B	C	D	E	F	G	H	J	K
.394	.394	.150	.122	.075	.098	.038	.026	.051	.038
10.01	10.01	3.81	3.10	1.90	2.49	0.97	0.66	1.29	0.97
L	M								
.046	.434								
1.17	11.02								
									Wt.
									grams
									0.7

Note: Please refer to case style drawing for details

NOTES

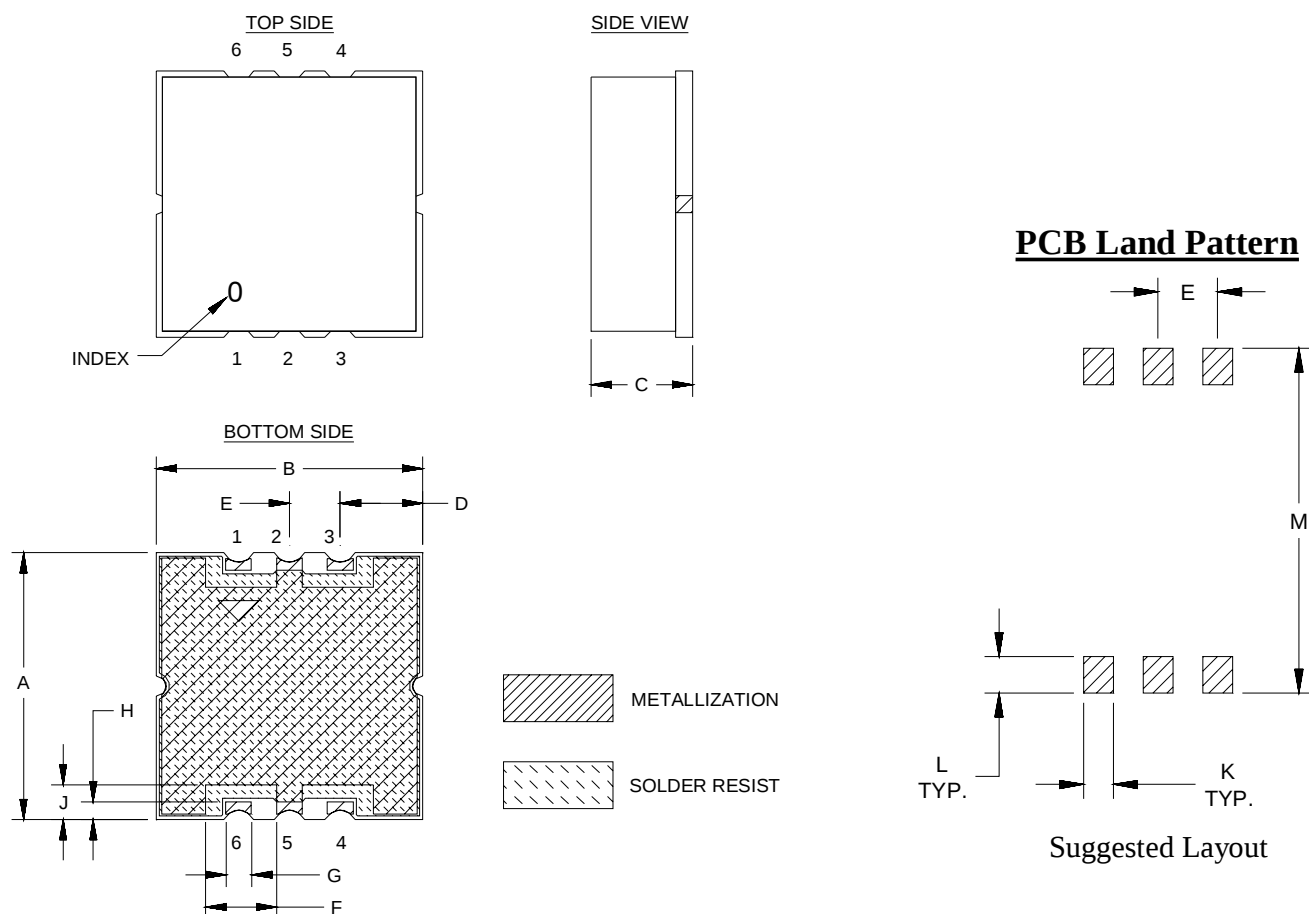
- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard. Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp

Mini-Circuits®

www.minicircuits.com P.O. Box 350166, Brooklyn, NY 11235-0003 (718) 934-4500 sales@minicircuits.com

PAGE 2 OF 2

Outline Dimensions



CASE #	A	B	C	D	E	F	G	H	J	K	L	M	WT. GRAMS
HE1354	.394 (10.01)	.394 (10.01)	.150 (3.81)	.122 (3.10)	.075 (1.90)	.098 (2.49)	.038 (0.97)	.026 (0.66)	.051 (1.29)	.038 (0.97)	.046 (1.17)	.434 (11.02)	0.7

Dimensions are in inches (mm). Tolerances: 2 Pl. $\pm .03$; 3 Pl. $\pm .015$

Notes:

- Case material: Nickel-Silver alloy.
- Base: Printed wiring laminate.
- Termination finish:
For RoHS Case Styles: 3-5 μ inch (.08-.13 microns) Gold over 120-240 μ inch (3.05-6.10 microns) Nickel plate.
For RoHS-5 Case Styles: Tin-Lead plate.



P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site

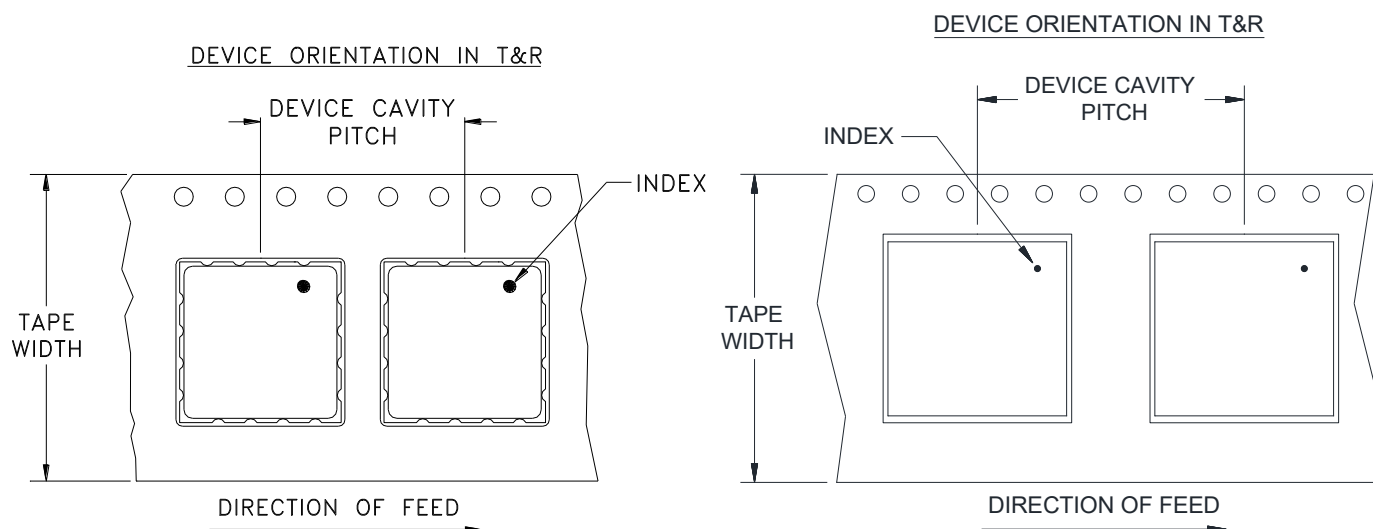


The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

RF/IF MICROWAVE COMPONENTS



Tape & Reel Packaging TR-F37



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
24	16	7	Small quantity standards (see note)	10
				20
				50
				100
		13	Standard	200
				500

Note: Please consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf



INTERNET <http://www.minicircuits.com>

P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661

Distribution Centers NORTH AMERICA 800-654-7949 • 417-335-5935 • Fax 417-335-5945 • EUROPE 44-1252-832600 • Fax 44-1252-837010

Mini-Circuits ISO 9001 & ISO 14001 Certified



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85° C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
HAST	130°C, 85% RH, 96 hours	JESD22-A110
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutectic Process: 225°C peak Pb-Free Process, 245°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Vibration (High Frequency)	20g peak, 20-2000 Hz, 4 times in each of three axes (total 12)	MIL-STD-883, Method 2007.3, Condition A
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215